



STN4440 Pb
Lead-free

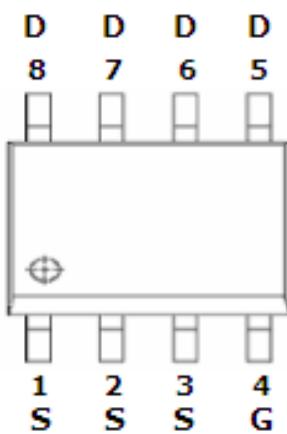
N Channel Enhancement Mode MOSFET

5.0A

DESCRIPTION

STN4440 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as power management and other battery powered circuits where high-side switching.

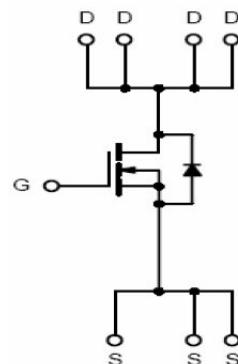
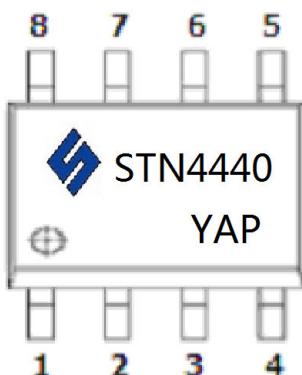
PIN CONFIGURATION SOP-8



FEATURE

- 60V/10.0A, $R_{DS(ON)} = 50m\Omega$ (Typ.)
@ $V_{GS} = 10V$
- 60V/8.0A, $R_{DS(ON)} = 70m\Omega$
@ $V_{GS} = 4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOP-8 package design

PART MARKING



Y: Year Code

A: Product Code

P: Process Code

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ABSOULTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	VDSS	60	V
Gate-Source Voltage	VGSS	±20	V
Continuous Drain Current (TJ=150°C)	ID TA=25°C TA=70°C	5.0 4.0	A
Pulsed Drain Current	IDM	20	A
Continuous Source Current (Diode Conduction)	IS	4.0	A
Power Dissipation	PD TA=25°C TA=70°C	2.5 1.6	W
Operation Junction Temperature	TJ	150	°C
Storage Temperature Range	TSTG	-55/150	°C
Thermal Resistance-Junction to Ambient	RθJA	80	°C/W



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ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID=250uA	60			V	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=250uA	1.0		3.0	V	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =48V, V _{GS} =0V			1	uA	
		V _{DS} =48V, V _{GS} =0V T _J =5°C			5		
On-State Drain Current	I _{D(on)}	V _{DS} ≥5V, V _{GS} =10V	20			A	
Drain-source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A		50		mΩ	
		V _{GS} =4.5V, I _D =8A		70			
Forward Transconductance	g _{fs}	V _{DS} =5V, I _D =6.2AV		11		S	
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Q _g	V _{DS} =30V, V _{GS} =10V I _D =5A		15		nC	
Gate-Source Charge	Q _{gs}			1.9			
Gate-Drain Charge	Q _{gd}			2.8			
Input Capacitance	C _{iss}	V _{DS} = 30V, V _{GS} =0V F=1MHz		1500		pF	
Output Capacitance	C _{oss}			80			
Reverse TransferCapacitance	C _{rss}			35			
Turn-On Time	t _{d(on)} tr	V _{DD} =10V, R _L = 6Ω V _{DS} =30V, R _G =3Ω		5.1	7	nS	
				2.6	4		
Turn-Off Time	t _{d(off)} tf			16	20		
				2.5	3		

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TYPICAL CHARACTERISTICS

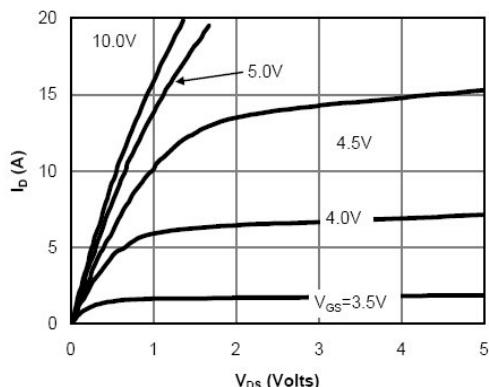


Fig 1: On-Region Characteristics

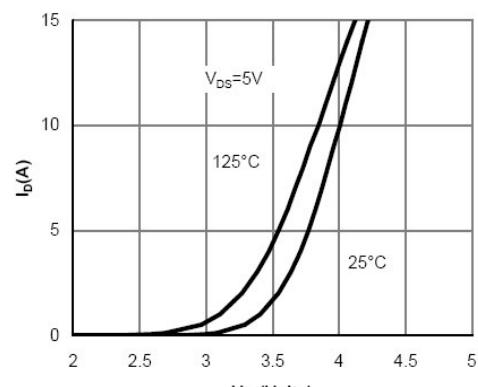


Figure 2: Transfer Characteristics

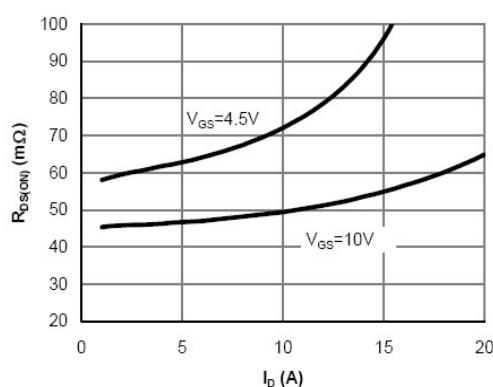


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

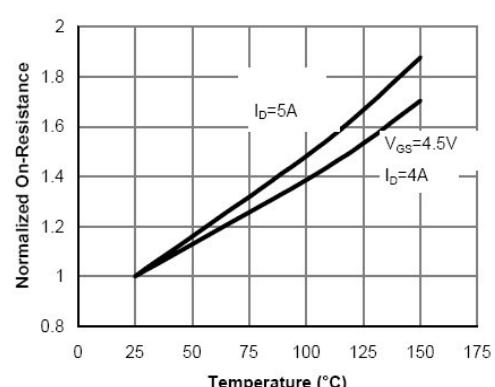


Figure 4: On-Resistance vs. Junction Temperature

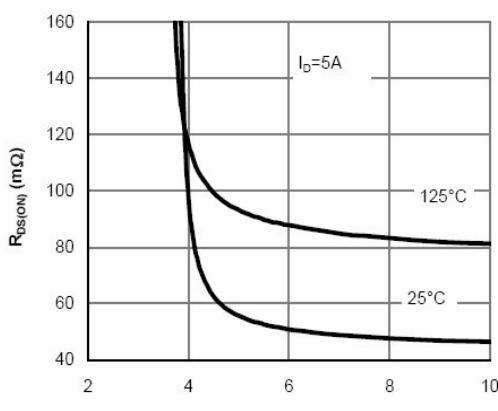


Figure 5: On-Resistance vs. Gate-Source Voltage

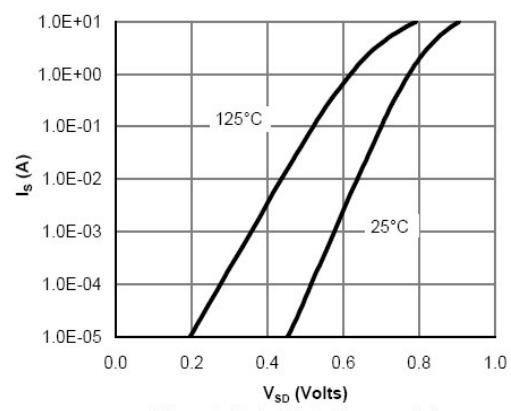


Figure 6: Body-Diode Characteristics

TYPICAL CHARACTERISTICS

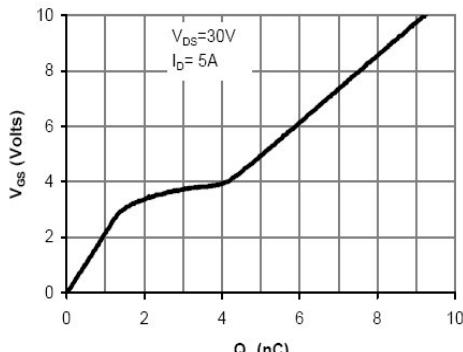


Figure 7: Gate-Charge Characteristics

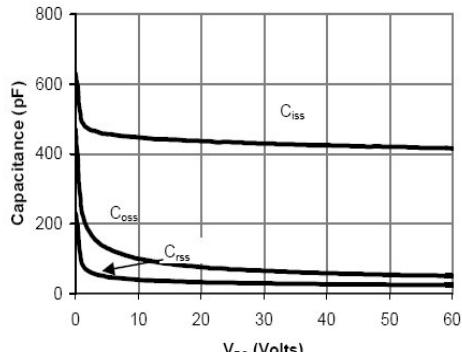


Figure 8: Capacitance Characteristics

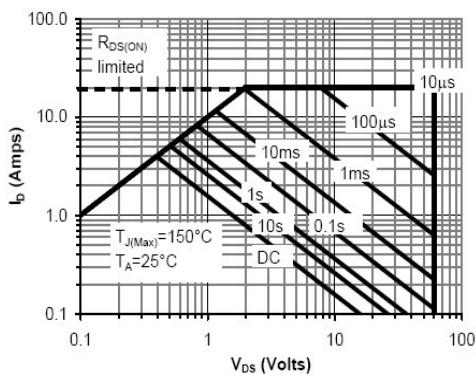


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

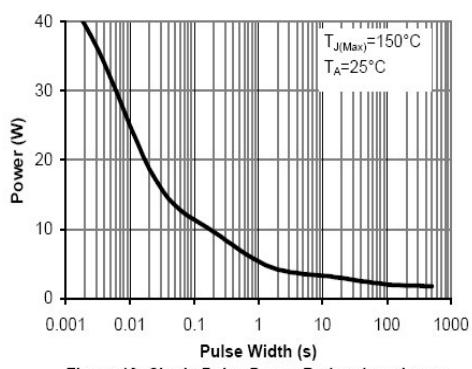


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

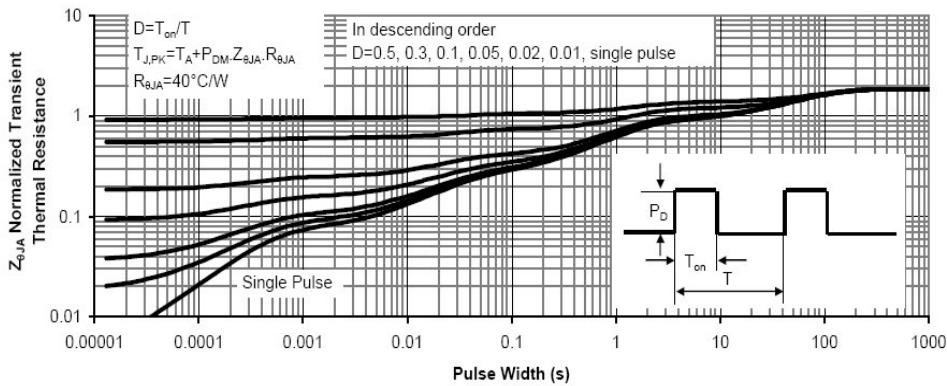


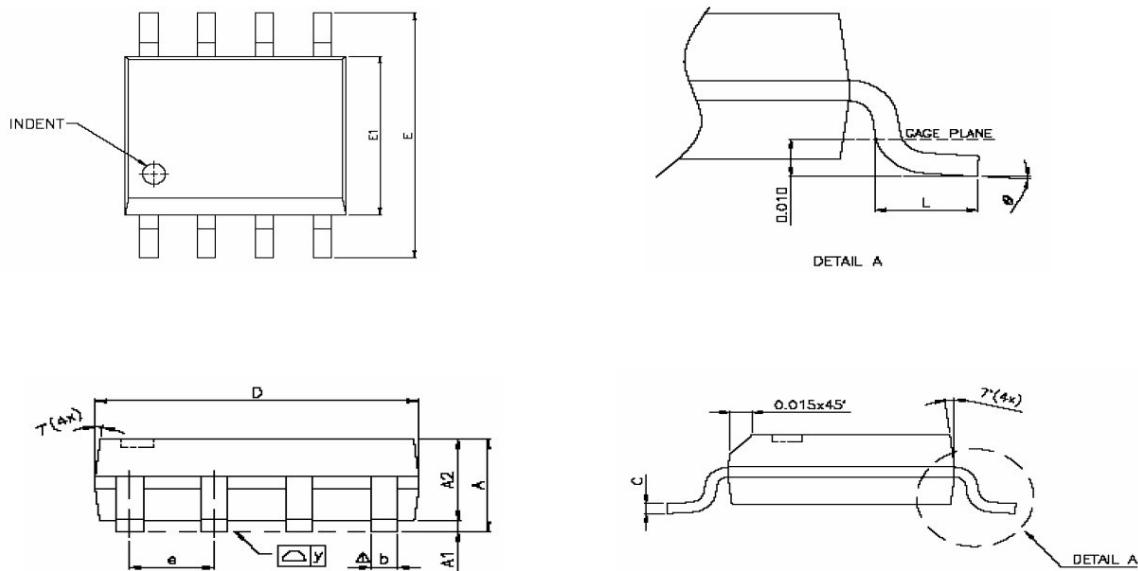
Figure 11: Normalized Maximum Transient Thermal Impedance



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PACKAGE OUTLINE SOP-8P



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10	—	0.25	0.004	—	0.010
A2	—	1.45	—	—	0.057	—
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	—	1.27	—	—	0.050	—
L	0.38	0.71	1.27	0.015	0.028	0.050
$\triangle y$	—	—	0.076	—	—	0.003
θ	0°	—	8°	0°	—	8°

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